

8961726 TEXAS INSTR (OPTO)

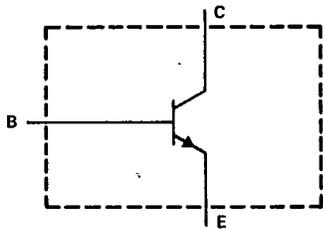
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TIP75, TIP75A, TIP75B, TIP75C
N-P-N SILICON POWER TRANSISTORS

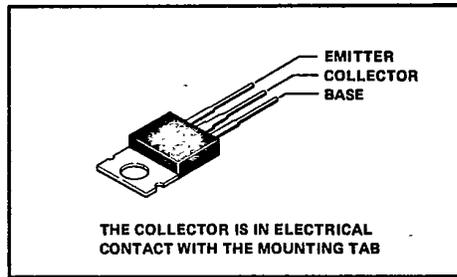
APRIL 1978 -- REVISED OCTOBER 1984

- 65 W at 25°C Case Temperature
- 5 A Peak Collector Current
- High-Voltage, High-Forward and Clamped Reverse Energy Circuit Characteristics
- Reverse-Bias SOA . . . 200 V to 400 V, 3 A
- Designed for Automotive Ignition, Linear Amplifier, and Switching Regulator Applications

device schematic



TO-220AB PACKAGE



absolute maximum ratings at 25°C case temperature (unless otherwise noted)

| | TIP75 | TIP75A | TIP75B | TIP75C |
|--|-----------------------|--------|--------|--------|
| Collector-base voltage | 350 V | 400 V | 450 V | 500 V |
| Collector-emitter voltage ($I_B = 0$) | 200 V | 250 V | 300 V | 400 V |
| Emitter-base voltage | 8 V | | | |
| Continuous collector current | 3 A | | | |
| Peak collector current (see Note 1) | 5 A | | | |
| Continuous base current | 1.5 A | | | |
| Safe operating areas at (or below) 25°C case temperature | See Figures 10 and 11 | | | |
| Continuous device dissipation at (or below) 25°C case temperature (see Note 2) | 65 W | | | |
| Continuous device dissipation at (or below) 25°C free-air temperature (see Note 3) | 2 W | | | |
| Operating collector junction and storage temperature range | - 65°C to 150°C | | | |
| Lead temperature 3,2 mm (0.125 inch) from case for 10 seconds | 260°C | | | |

- NOTES: 1. This value applies for $t_w \leq 5$ ms, duty cycle ≤ 10 %.
 2. Derate linearly to 150°C case temperature at the rate of 0.52 °C/W or refer to Dissipation Derating Curve, Figure 12.
 3. Derate linearly to 150°C free-air temperature at the rate of 16 °C/mW or refer to Dissipation Derating Curve, Figure 13.

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N-P-N SILICON POWER TRANSISTORS

electrical characteristics at 25°C case temperature

| PARAMETER | TEST CONDITIONS | TIP75 | | TIP75A | | TIP75B | | TIP75C | | UNIT |
|-----------------------|--|-------|-----|--------|-----|--------|-----|--------|-----|------|
| | | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | |
| V(BR)CBO | I _C = 10 mA, I _E = 0, See Note 4 | 350 | | 400 | | 450 | | 500 | | V |
| V(BR)CEO | I _C = 10 mA, I _B = 0, See Note 4 | 200 | | 250 | | 300 | | 400 | | V |
| V _{CEX(sus)} | I _C = 3 A, See Figure 1 | 200 | | 250 | | 300 | | 400 | | V |
| I _{CEO} | V _{CE} = 150 V, I _B = 0 | | 150 | | 150 | | | | | μA |
| | V _{CE} = 250 V, I _B = 0 | | | | | 150 | | 150 | | |
| I _{CES} | V _{CE} = 300 V, V _{BE} = 0 | | 50 | | | | | | | μA |
| | V _{CE} = 350 V, V _{BE} = 0 | | | | 50 | | | | | |
| | V _{CE} = 400 V, V _{BE} = 0 | | | | | | 50 | | | |
| | V _{CE} = 450 V, V _{BE} = 0 | | | | | | | 50 | | |
| I _{EBO} | V _{EB} = 8 V, I _C = 0 | | 1 | | 1 | | 1 | | 1 | mA |
| h _{FE} | V _{CE} = 5 V, I _C = 0.5 A, See Notes 4 and 5 | 30 | 250 | 30 | 250 | 30 | 250 | 30 | 250 | |
| | V _{CE} = 2 V, I _C = 2 A, See Notes 4 and 5 | 12 | | 12 | | 12 | | 12 | | |
| | V _{CE} = 4 V, I _C = 3 A, See Notes 4 and 5 | 10 | | 10 | | 10 | | 10 | | |
| V _{BE} | I _B = 50 mA, I _C = 0.5 A, See Notes 4 and 5 | | 1 | | 1 | | 1 | | 1 | V |
| | I _B = 0.6 A, I _C = 3 A, See Notes 4 and 5 | | 1.2 | | 1.2 | | 1.2 | | 1.2 | |
| V _{CE(sat)} | I _B = 50 mA, I _C = 0.5 A, See Notes 4 and 5 | | 0.5 | | 0.5 | | 0.5 | | 0.5 | V |
| | I _B = 0.6 A, I _C = 3 A, See Notes 4 and 5 | | 1.9 | | 1.9 | | 1.9 | | 1.9 | |
| h _{fe} | V _{CE} = 5 V, I _C = 0.5 A, f = 1 kHz | 30 | | 30 | | 30 | | 30 | | |
| h _{fe} | V _{CE} = 5 V, I _C = 0.5 A, f = 1 MHz | 10 | | 10 | | 10 | | 10 | | |
| C _{obo} | V _{CB} = 10 V, I _E = 0, f = 1 MHz | | 275 | | 275 | | 275 | | 275 | pF |

NOTES: 4. These parameters must be measured using pulse techniques, t_w = 300 μs, duty cycle ≤ 2%.
5. These parameters are measured with voltage-sensing contacts separate from the current-carrying contacts located within 3.2 mm (0.125 inch) from the device body.



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thermal characteristics

| PARAMETER | MIN | TYP | MAX | UNIT |
|-----------------------------|-----|------|-----|-----------------------------|
| $R_{\theta JC}$ | | 1.92 | | |
| $R_{\theta JA}$ | | 62.5 | | $^{\circ}\text{C/W}$ |
| $R_{\theta CHS}$ See Note 6 | | 0.7 | | |
| $C_{\theta C}$ | | 0.9 | | $\text{J}/^{\circ}\text{C}$ |

NOTE 6: This parameter is measured using 0.08 mm (0.003-inch) mica insulator with Dow-Corning 11 compound on both sides of the insulator, a 0.138-32 (formerly 6-32) mounting screw with bushing, and a mounting torque of 0.9 newton-meter (8 inch-pounds).

resistive-load switching characteristics at 25 $^{\circ}\text{C}$ case temperature

| PARAMETER | TEST CONDITIONS [†] | MIN | TYP | MAX | UNIT |
|-----------|--|-----|------|-----|------|
| t_d | | | 20 | | ns |
| t_r | $I_C = 2\text{ A},$ $I_{B1} = 0.2\text{ A},$ $I_{B2} = -0.2\text{ A},$ | | 340 | | |
| t_s | $V_{BE(\text{off})} = -4\text{ V},$ $R_L = 100\ \Omega,$ See Figure 2 | | 1400 | | |
| t_f | | | 800 | | |

[†] Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

inductive-load switching characteristics at 25 $^{\circ}\text{C}$ case temperature

| PARAMETER | TEST CONDITIONS [†] | MIN | TYP | MAX | UNIT |
|-----------|--|-----|------|-----|------|
| t_{sv} | | | 1700 | | ns |
| t_{sj} | $V_{(\text{clamp})} = \text{Min } V_{CEX(\text{sus})},$ $I_{B1} = 0.5\text{ A},$ $I_{B2} = -0.5\text{ A},$ $I_{CM} = 3\text{ A},$ See Figure 3 | | 2300 | | |
| t_{tv} | | | 700 | | |
| t_{ti} | | | 700 | | |
| t_{xp} | | | 1300 | | |

[†] Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

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TIP Devices

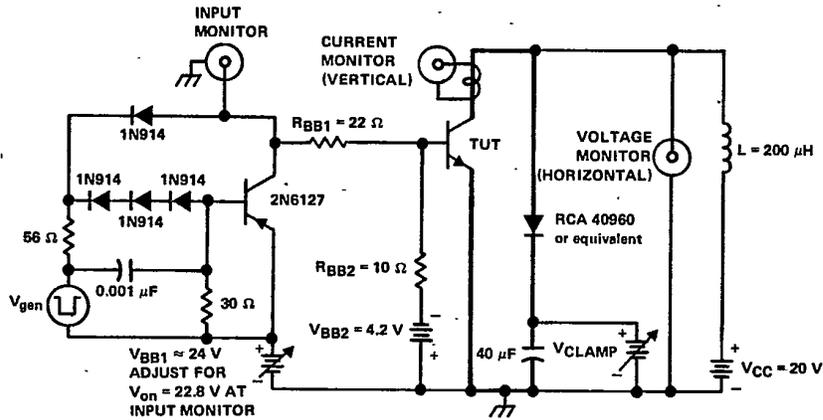
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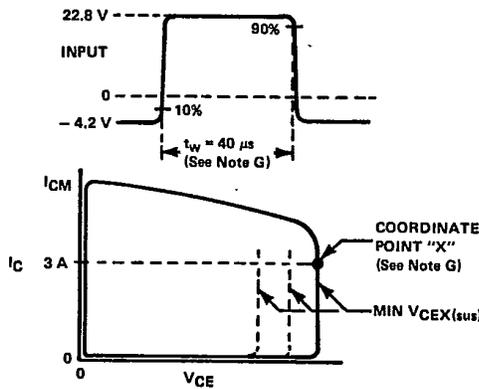
TIP75, TIP75A, TIP75B, TIP75C
N-P-N SILICON POWER TRANSISTORS

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PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT



INPUT WAVEFORM AND X-Y DISPLAY

- NOTES: A. V_{gen} is a -30-V pulse into a $50\ \Omega$ termination.
 B. The V_{gen} waveform is supplied by a generator with the following characteristics: $t_r \leq 15\text{ ns}$, $t_f \leq 15\text{ ns}$, $Z_{out} = 50\ \Omega$, $t_w = 40\ \mu\text{s}$, duty cycle $\leq 2\%$.
 C. Waveforms are monitored on an X-Y oscilloscope with the following characteristics: $t_r \leq 15\text{ ns}$, $R_{in} \geq 10\text{ M}\Omega$, $C_{in} \leq 11.5\text{ pF}$.
 D. Resistors must be noninductive types.
 E. The d-c power supplies may require additional bypassing in order to minimize ringing.
 F. Heavy lines denote copper bus 0.5 inch by 0.125 inch (12.7 mm by 3.2 mm) fabricated to have minimum inductance.
 G. Adjust input pulse duration until collector current is 3 A at point "X". I_{CM} must not exceed 5 A.

FIGURE 1. COLLECTOR-EMITTER SUSTAINING VOLTAGE TEST

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TIP Devices

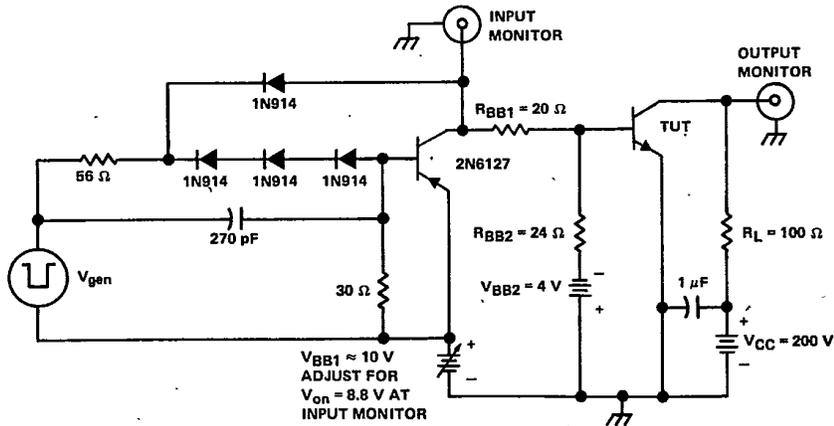
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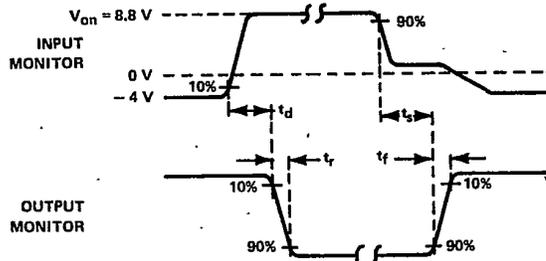
TIP75, TIP75A, TIP75B, TIP75C
N-P-N SILICON POWER TRANSISTORS

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PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT



VOLTAGE WAVEFORMS

- NOTES:
- A. V_{gen} is a -30-V pulse into a 50 Ω termination.
 - B. The V_{gen} waveform is supplied by a generator with the following characteristics: $t_r \leq 15$ ns, $t_f \leq 15$ ns, $Z_{out} = 50 \Omega$, $t_w = 20 \mu$ s, duty cycle $\leq 2\%$.
 - C. Waveforms are monitored on an oscilloscope with the following characteristics: $t_r \leq 15$ ns, $R_{in} \geq 10$ M Ω , $C_{in} \leq 11.5$ pF.
 - D. Resistors must be noninductive types.
 - E. The d-c power supplies may require additional bypassing in order to minimize ringing.

FIGURE 2. RESISTIVE-LOAD SWITCHING



TIP Devices

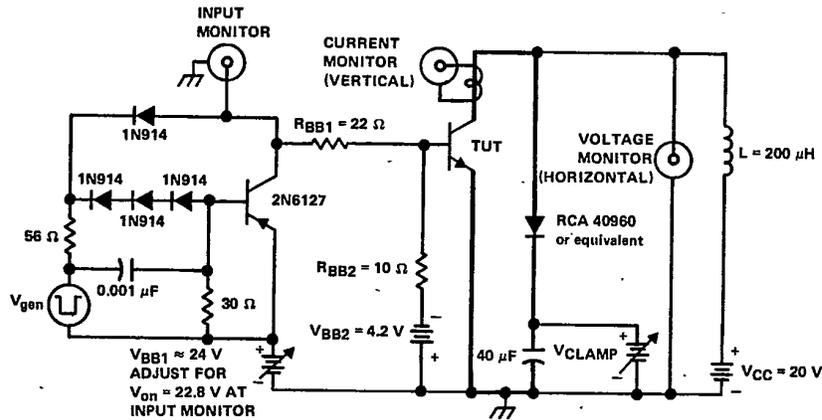
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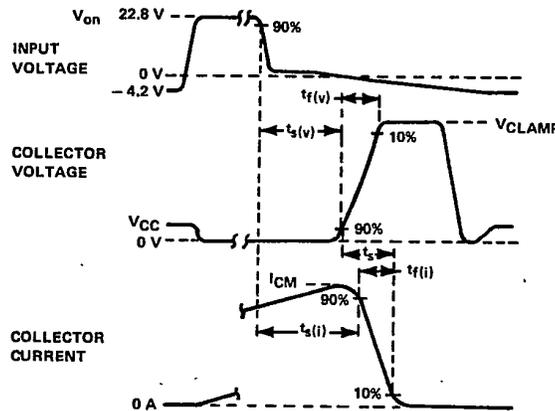
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N-P-N SILICON POWER TRANSISTORS

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PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT



WAVEFORMS

- NOTES: A. V_{gen} is a -30-V pulse into a $50\ \Omega$ termination.
 B. The V_{gen} waveform is supplied by a generator with the following characteristics: $t_r \leq 15\text{ ns}$, $t_f \leq 15\text{ ns}$, $Z_{out} = 50\ \Omega$, $t_w \approx 25\ \mu\text{s}$, duty cycle $\leq 2\%$. Pulse duration is adjusted for $I_{CM} = 3\text{ A}$.
 C. Waveforms are monitored on an oscilloscope with the following characteristics: $t_r \leq 15\text{ ns}$, $R_{in} \geq 10\text{ M}\Omega$, $C_{in} \leq 11.5\text{ pF}$.
 D. Resistors must be noninductive types.
 E. The d-c power supplies may require additional bypassing in order to minimize ringing.
 F. Heavy lines denote copper bus 0.5 inch by 0.125 (12.7 mm by 3.2 mm) fabricated to have minimum inductance.

FIGURE 3. INDUCTIVE-LOAD SWITCHING TIMES.

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TYPICAL CHARACTERISTICS

STATIC FORWARD CURRENT TRANSFER RATIO
vs
COLLECTOR CURRENT

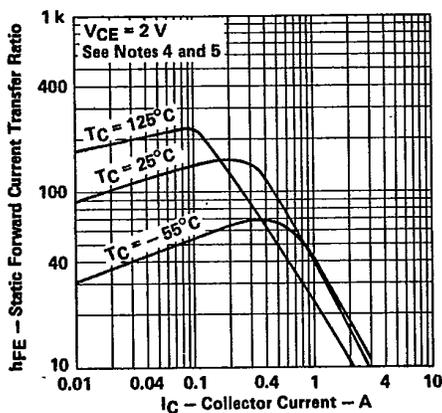


FIGURE 4

STATIC FORWARD CURRENT TRANSFER RATIO
vs
COLLECTOR CURRENT

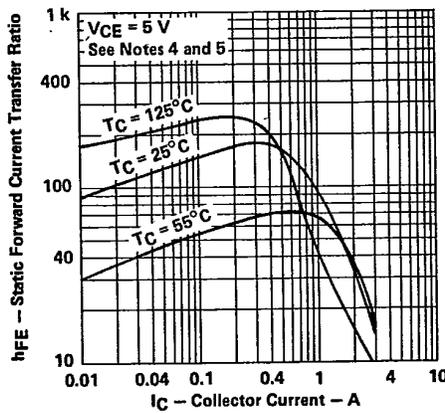


FIGURE 5

BASE-EMITTER VOLTAGE
vs
COLLECTOR CURRENT

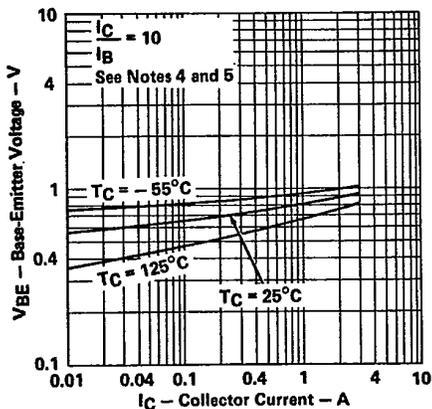


FIGURE 6

COLLECTOR-EMITTER SATURATION VOLTAGE
vs
COLLECTOR CURRENT

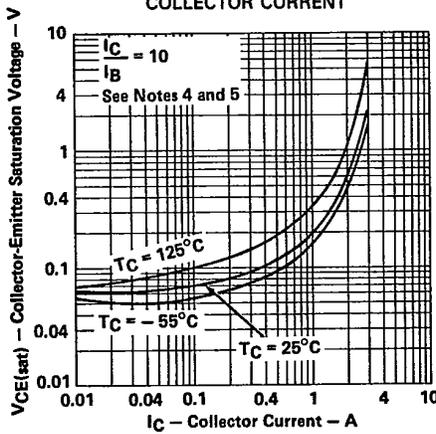


FIGURE 7

- NOTES: 4. These parameters must be measured using pulse techniques, $t_w = 300 \mu s$, duty cycle $< 2\%$.
5. These parameters are measured with voltage-sensing contacts separate from the current-carrying contacts and located within 3.2 mm (0.125 inch) from the device body.

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TYPICAL CHARACTERISTICS

COLLECTOR CUTOFF CURRENT
vs
TEMPERATURE

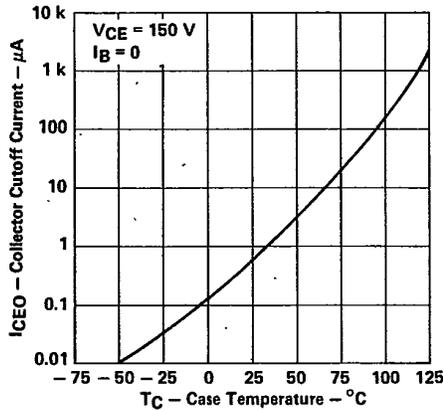


FIGURE 8

COLLECTOR CUTOFF CURRENT
vs
TEMPERATURE

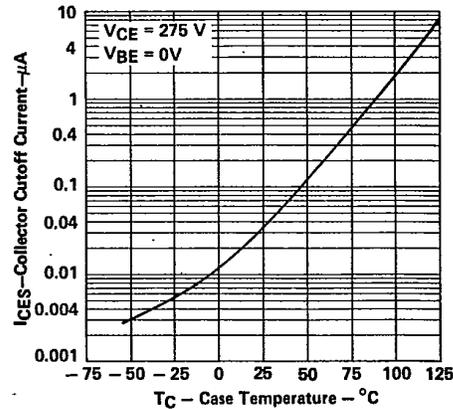


FIGURE 9

MAXIMUM SAFE OPERATING AREA

FORWARD-BIAS SAFE OPERATING AREA

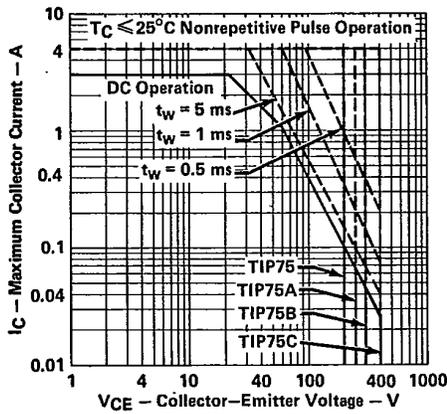


FIGURE 10

REVERSE-BIAS SAFE OPERATING AREA

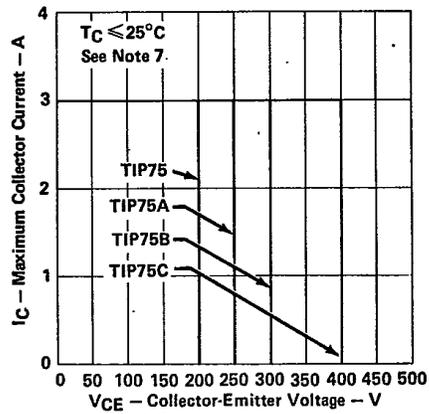


FIGURE 11

NOTE 6: This combination of maximum voltage and current may be achieved only when switching from saturation to cutoff with a clamped inductive load as in Figure 3.

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THERMAL INFORMATION

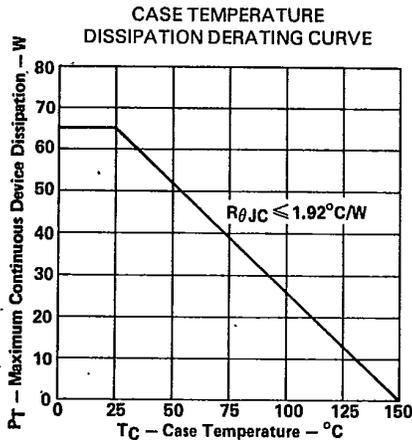


FIGURE 12

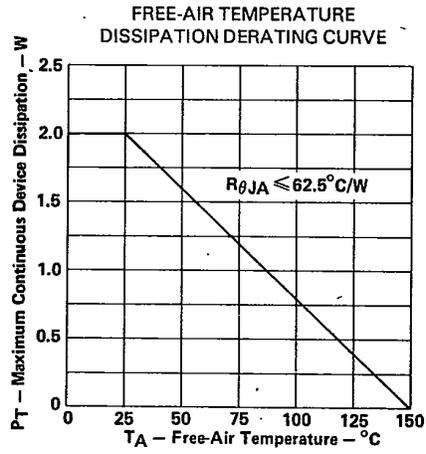


FIGURE 13

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